

**PATENT** 

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Jerome J. CARTMELL, et al.

Appl. No.: 10/812,291

Art Unit: 2189

Filed: March 29, 2004

Examiner: VO, Thanh Duc

For: MIRRORED MEMORY Atty. Docket: EMS-06601

### **DECLARATION UNDER 37 CFR 1.131**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

- 1. I understand that the originally-named inventors of the above-captioned U.S. Patent Application No. 10/812,291, filed in the United States on March 29, 2004 (hereinafter "the present patent application") are Jerome J. Cartmell, Qun Fan, Steven T. McClure, Robert DeCrescenzo, Haim Kopylovitz and Eli Shagam. I am one of the originallynamed inventors.
- 2. I have assigned my interest in the present patent application to EMC Corporation.
- 3. I understand that U.S. Patent Application Pub. No. 2004/0205384 A1 to Lai et al., filed in the United States on February 18, 2004, and published October 14, 2004, has been cited by the Examiner against the present patent application.
- 4. Attached hereto as Exhibit A is a copy of an internal EMC document prepared by the inventors entitled "Symm7 Mirrored Memory Conceptual Review" containing presentation materials addressing hardware implementation, software requirements and limitations, and software design concepts concerning Symm7 Mirrored Memory. The dates of Exhibit A have been redacted; however, all of the redacted dates are from a time prior to February 18, 2004.
- Specifically, pages 3-5 of the "Symm7 Mirrored Memory Conceptual Review" document 5. of Exhibit A address "Mirrored Memory Hardware Implementation," pages 11-14 address software design concepts including "6 Different Mirrored Memory System States" and "Memory Access Functional Layering," and pages 20-25 address "Failover & Synchronization State."

- 6. Exhibit A, and particularly the above-noted portions, indicates that, before February 18, 2004, I and the other inventors conceived of and developed the invention set forth in the present patent application and including at least the following features:
  - a) "A method of accessing data memory, comprising:

writing data to a first memory location and to a second memory location in response to a request to write data to a memory address that corresponds to both locations, wherein the first and second memory locations are mirrored;

in response to a request to read data from the memory address, reading data from the first memory location or the second memory location based on load balancing; and

accessing data from the second memory location in response to a request to access data at the memory address when memory hardware corresponding to the first memory location has failed."

b) "Computer software, stored in a computer-readable medium, that accesses data memory, comprising:

executable code that writes data to a first memory location and to a second memory location in response to a request to write data to a memory address that corresponds to both locations, wherein the first and second memory locations are mirrored;

executable code that reads data from the first memory location or the second memory location based on load balancing in response to a request to read data from the memory address; and

executable code that accesses data from the second memory location in response to a request to access data at the memory address when memory hardware corresponding to the first memory location has failed."

- c) "A data storage device, comprising:
  - a plurality of disk drives;
  - an internal volatile memory; and
  - a plurality of directors coupled to the memory, wherein some of the directors are coupled to the disk drives and some of the directors allow external access to the data storage device and wherein each of the directors access the memory by writing data to a first memory location and to a second memory location in response to a request to write data to a memory address that corresponds to both locations, wherein the first and second memory locations are mirrored, in response to a request to read data from the memory address, the directors read data from the first memory location or the second memory location based on load balancing, and the directors access data from the second memory location in response to a request to access data at the memory address when memory hardware corresponding to the first memory location has failed."

7. Further, attached hereto as Exhibit B is a copy of e-mail exchanges by and among the inventors concerning development of the subject matter of the present patent application. The dates of these documents have been redacted; however, all of the redacted dates are from a time between February 18, 2004, and the March 29, 2004, filing date of the present patent application.

EMC

- 8. All of the work that is reflected in the contents of Exhibits A and B was performed in the US or other WTO or NAFTA country.
- 9. Furthermore, during the period between February 18, 2004, and the March 29, 2004, filing date of the present patent application, I and the other inventors received communications from and responded to EMC's outside patent counsel concerning drafts of the present patent application that were being prepared by the outside patent counsel.
- 10. To the best of my knowledge and belief, I and the other inventors are the only individuals known to me to have conceived of and developed the above-noted features, and we were diligent from a time prior to February 18, 2004, until the invention was constructively reduced to practice by filing the present patent application on March 29, 2004.
- 11. I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the above-captioned Application for Patent or any patent issuing thereon.

Respectfully submitted.

Date: 12/13/2006

Date: 12/13/2006

Date: 12/13/06

Steven T. McClure

Robert DeCrescenzo

Date: Haim Kopylovitz

Eli Shagam

- 7. Further, attached hereto as Exhibit B is a copy of e-mail exchanges by and among the inventors concerning development of the subject matter of the present patent application. The dates of these documents have been redacted; however, all of the redacted dates are from a time between February 18, 2004, and the March 29, 2004, filing date of the present patent application.
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Respectfully submitted,

| Date:            |                    |
|------------------|--------------------|
|                  | Jerome J. Cartmell |
| Date:            |                    |
|                  | Qun Fan            |
| Date:            |                    |
|                  | Steven T. McClure  |
| Date:            |                    |
| ·                | Robert DeCrescenzo |
| Date: 12/13/2006 | 1.15               |
|                  | Haim Kopylovitz    |
| Date:            |                    |
|                  | Eli Shagam         |

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Respectfully submitted,

### Symm7 Mirrored Memory Conceptual Review

Jerry Cartmell Bob DeCrescenzo Chun Fan Haim Kopylovitz Steve McClure Eli Shagam

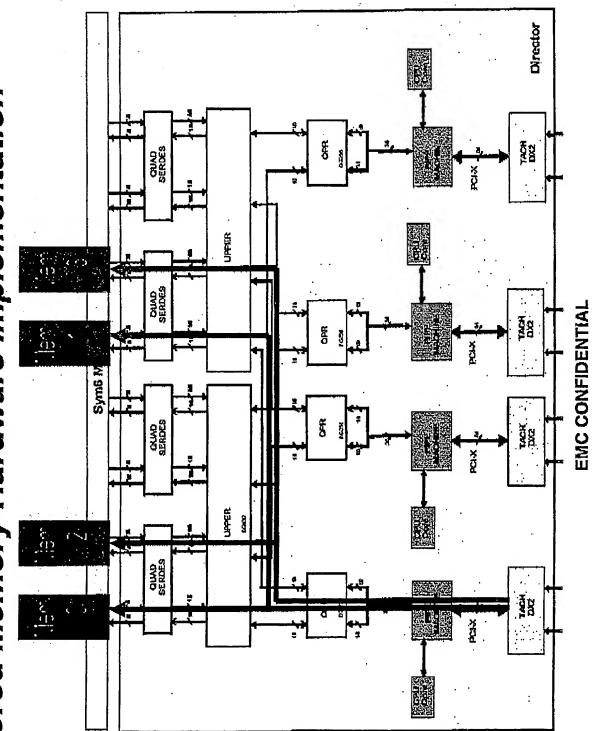
### Presentation Overview

- Hardware Implementation
- Software Requirements & Limitations
- Software Design Concepts
- Project Status
- Q & A

### Hardware Implementation

- Similar dual write implementation as was available (but not used) in Symm6
- Memory boards have fixed mirrored board and director port pairs. For example:
- Memory board 0 is always paired with memory board
- Director port 0 is always mirrored with director port 4





Mirrored Memory Hardware Implementation

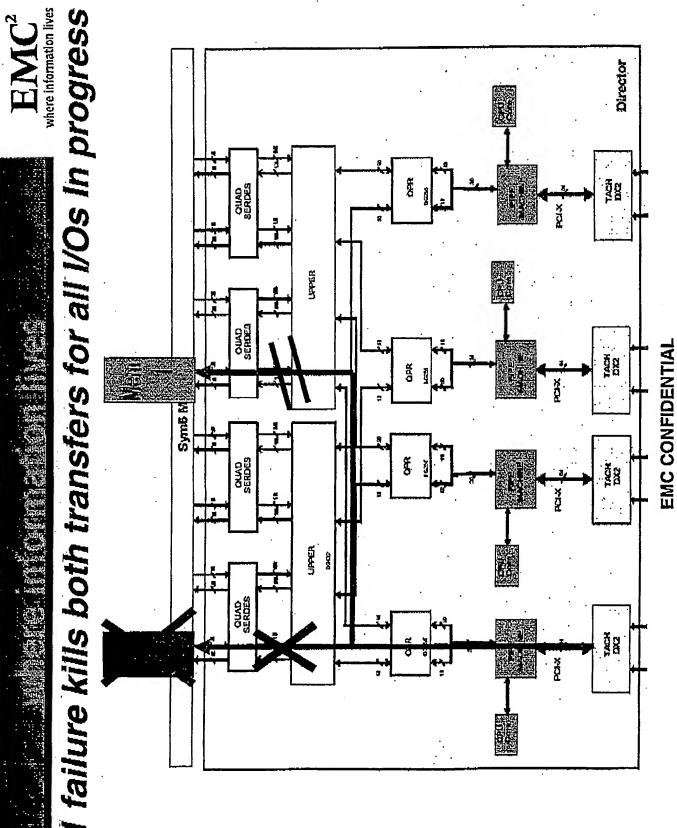


### Hardware Implementation

- Similar dual write implementation as was available (but not used) in Symm6
- Memory boards have fixed mirrored board and director port pairs. For example:
- Memory board 1 is always paired with memory board 2
- Director port 0 is always mirrored with director port 4
- No global hardware switch for dual write on or off. Dual write is on all the time by default
- Can turn off dual write on a per I/O basis

### Hardware Anomalies

- Hardware will not support dual writes on atomic operations (MCMS). Software will have to do 2 separate accesses.
- Estimated performance penalty on I/Os per sec
  - FA -- 10.6%
- FICON -- 11.8%
- DA -- 8.3%
- In the case of a failure in 1 transfer of the dual write, the hardware will stop both transfers.



Software Requirements & Limitations

- Software only supports mirrored memory configurations.
- Software shall do FULL mirroring of global memory mirroring. There will not be any separate Read & Write cache.
- board. It will not failover all memory boards in the Software shall only failover an individual memory system on a single failure.
- Error failover time shall be no worse than the time it takes to do an online code upgrade.

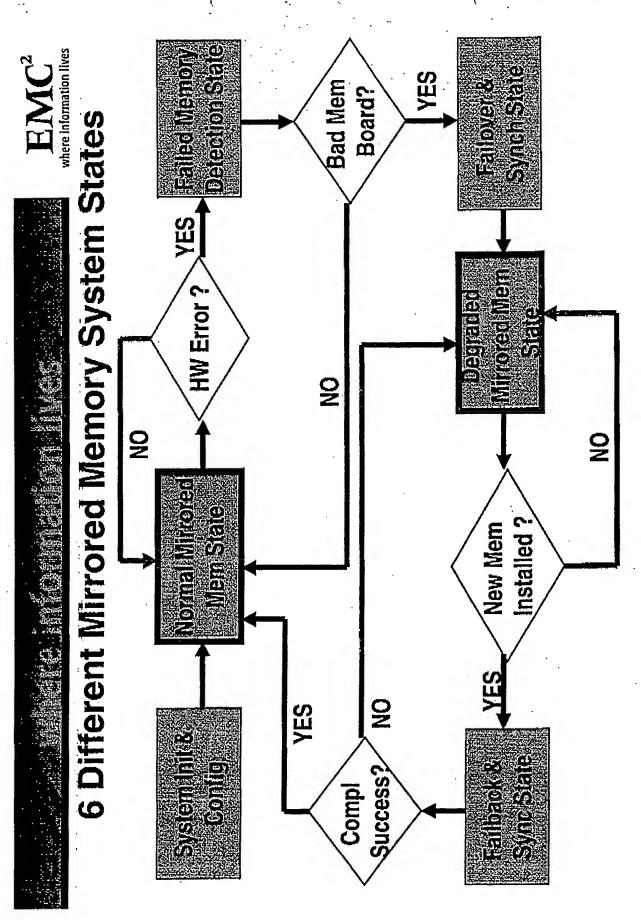
### **EMC**<sup>2</sup> where information lives

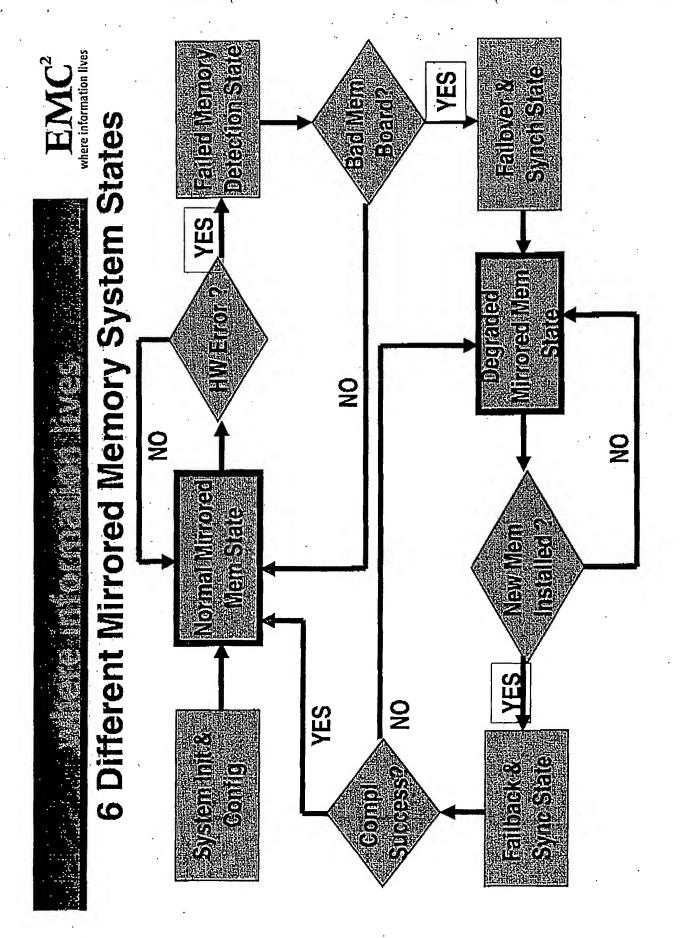
# Software Requirements & Limitations (Cont)

- All mirrored memory knowledge and handling is done in the HW core services layer.
- Software will no longer support things like port failover or multibit recovery. All hard memory failures will invoke mirrored memory failover.
- Memory board replacements should be done with minimum User & Symmwin intervention – "Ease of Use"
- The software will continue to write user data to an unprotected memory board.



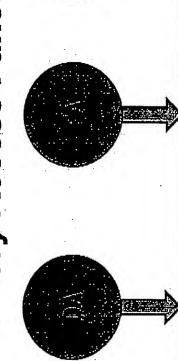
## Software Design Concept:

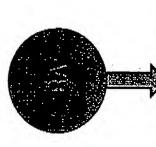


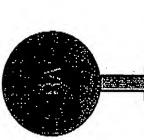


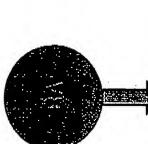
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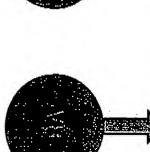
## Memory Access Functional Layering

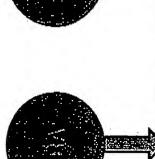


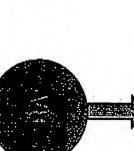


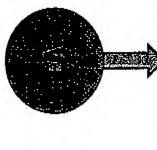


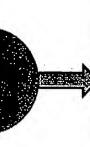


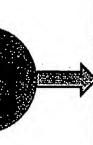


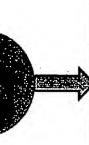


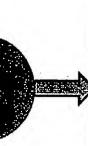
















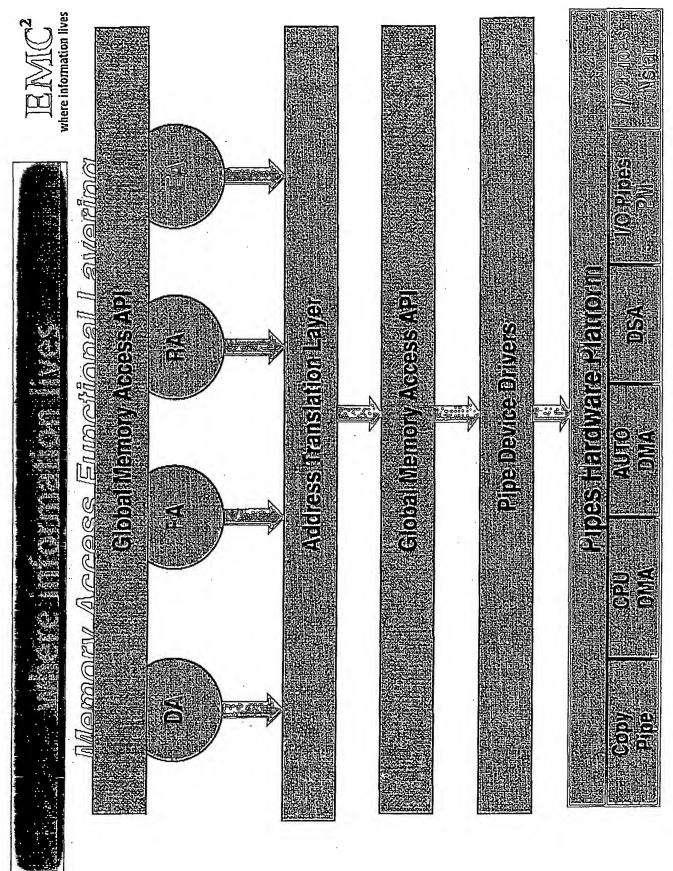
Global Memory Argess AP





Pless Hardware Palforn

DSA



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### Global Memory Abeass A.P.

- Manages all calls and return values from driver
- All error checking and error parsing
- Retries and basic error recovery
- Error & event tracing

# All knowledge of mirrored memory lives at this layer

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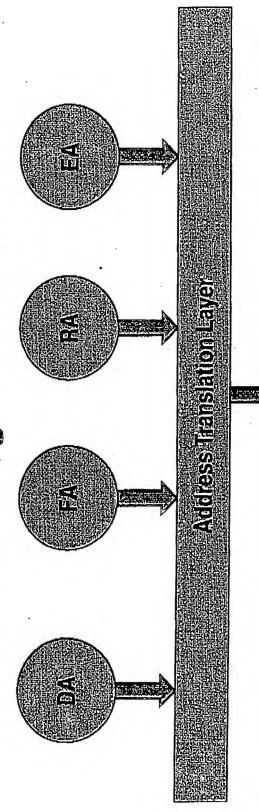
### **GMA Layer**

- responsible for maintaining the mirrored memory The Global Memory Access (GMA) layer will be states.
- The GMA layer will tell the driver to write the data to both location (Normal) or to a single location (Degraded).
- The GMA layer will need to handle all issues with the atomic (MCMS) operations for mirrored memory when in both normal & degraded mode.
- The GMA layer is where the read load balancing algorithm lives.

**NStar** 



## Normal & Degraded State

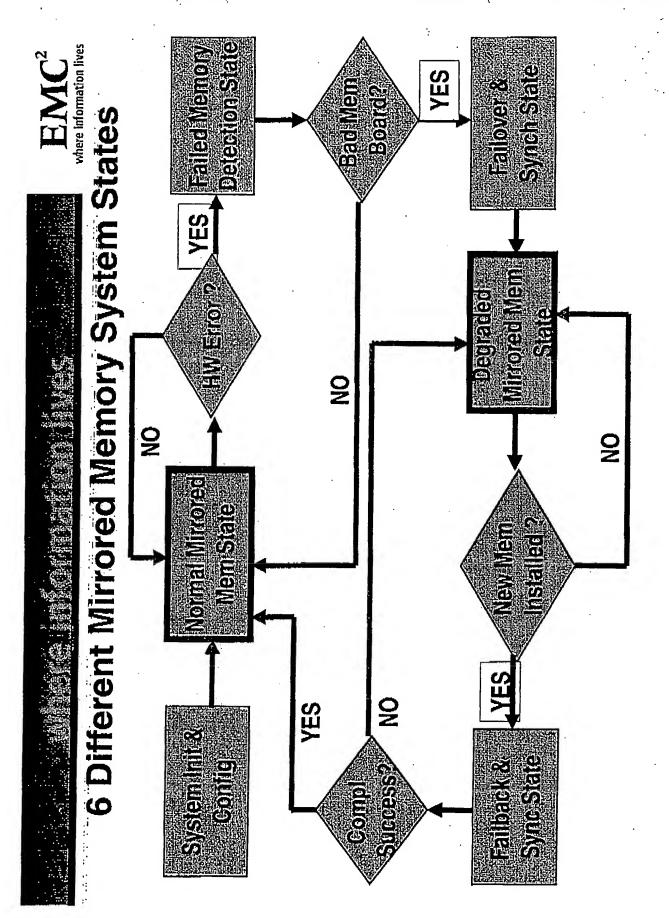


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### Failed Memory Detection State

- Main purpose of this phase is to diagnose a HW problem and decide if a memory board needs to be failed.
- The memory failure detection is encapsulated in the GMA layer.
- "Bad memory" detection is dependant on diagnosing where the problem resides.
- Some errors are obvious, but there are a subset of errors that it's difficult to determine if it's a memory problem.

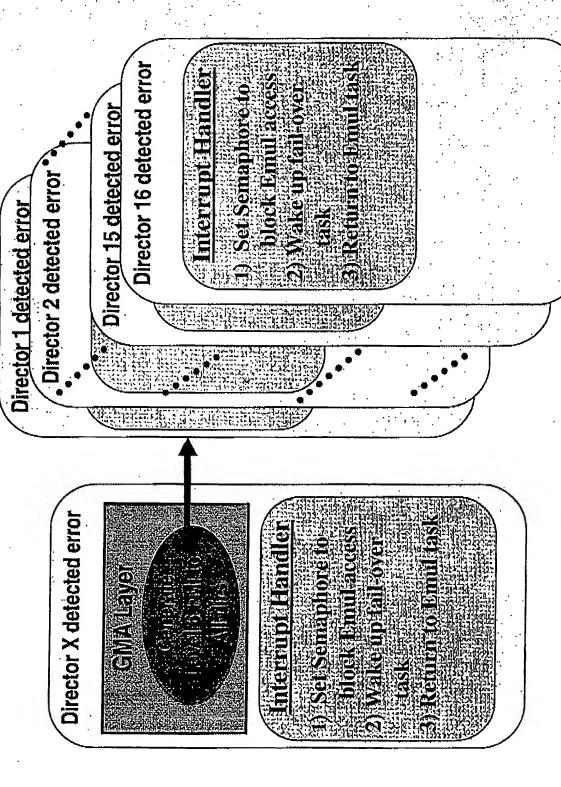


mechanism 2 ឲ្យជម្រាចកាមាល់ស Bad Mem? ,YES Potential CIM Y BEISHANS ALLED WARMORY DE TEGET From diver Globali Memory, Access AP **EMC CONFIDENTIAL** YES YES Symoli State Falloners

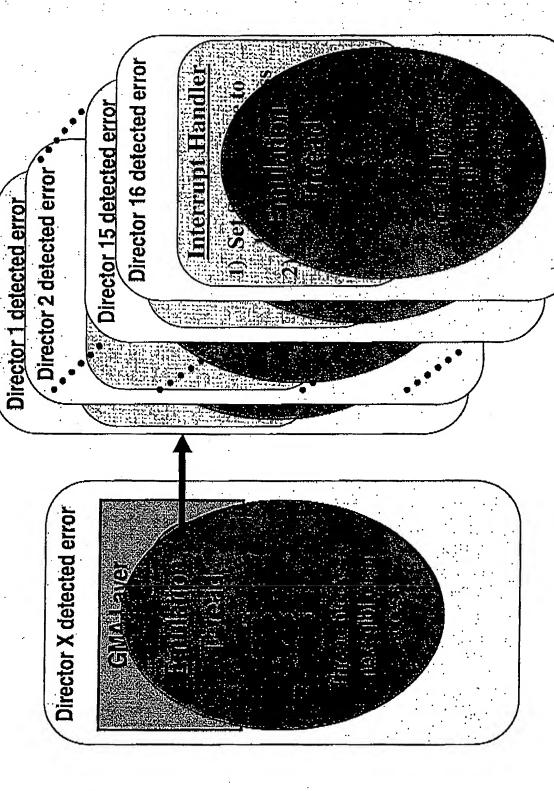
## Failover & Synchronization State

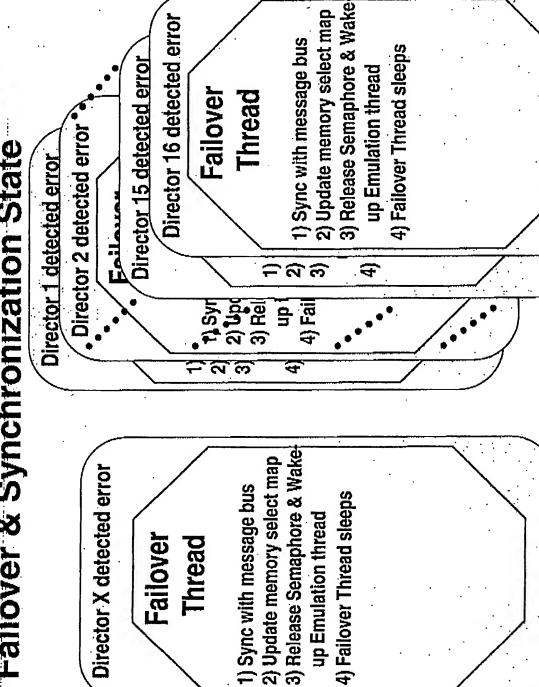
- Software will use a level 6 interrupt (FMI) to synchronize failover between all directors.
- communicate failover information between Software will use the message bus to directors.
- each director that will be invoked to perform the There will be a separate "fail-over" thread on entire failover procedure.
- All new I/Os in the system will be on hold while the failover is taking place.

**EMC**<sup>2</sup> where information lives

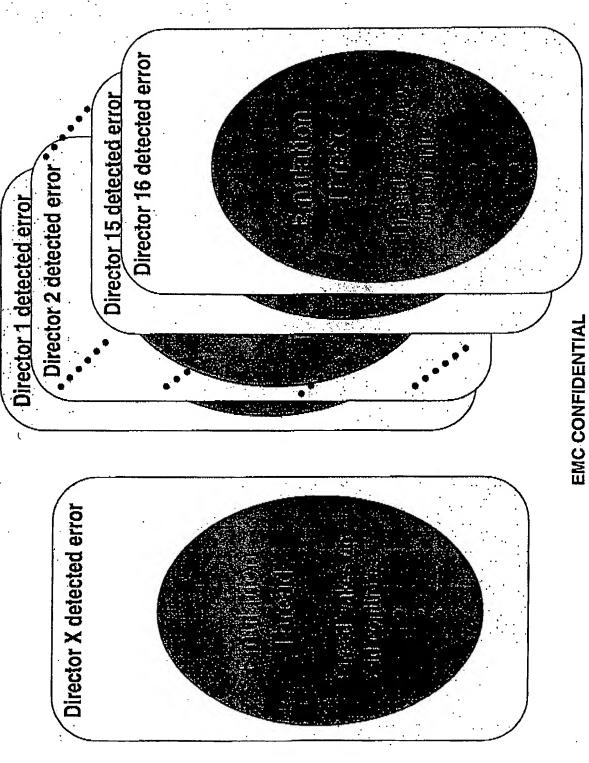


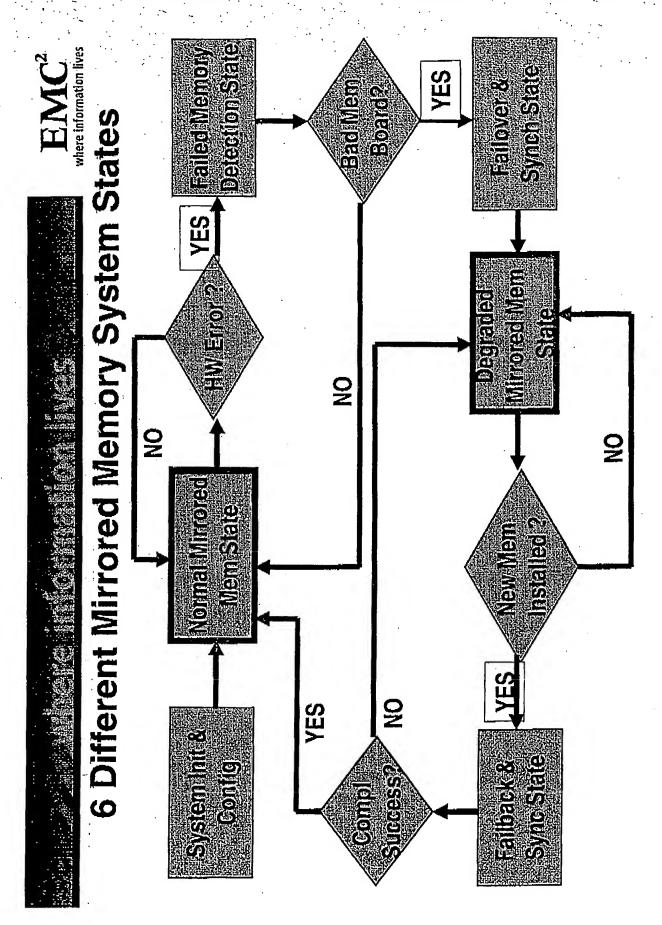






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### Failback & Synchronize State

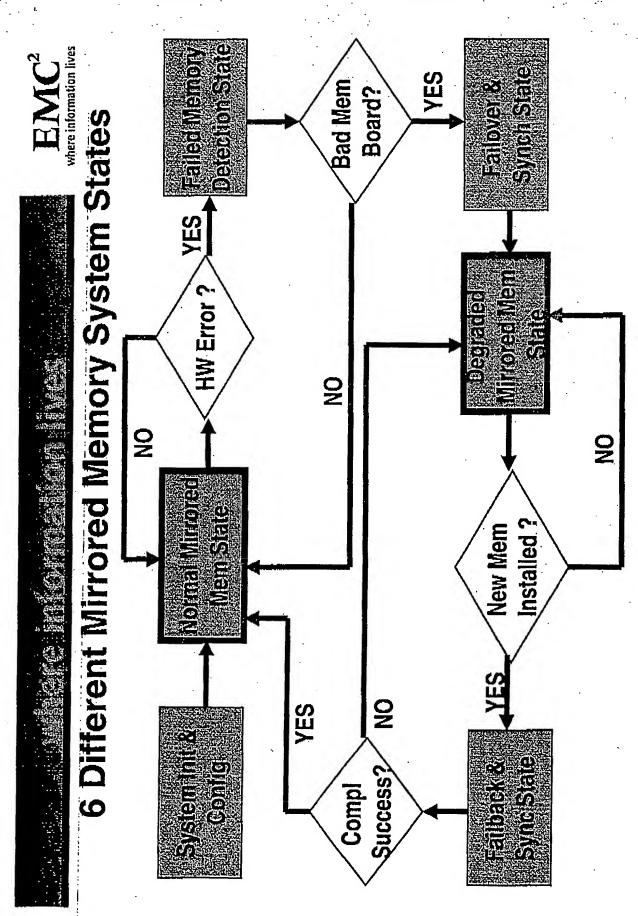
- The procedure to failback to a new memory board is split into 3 separate phases
- All 3 phases can be done without any user or Symmwin intervention
- All directors need to coordinate on each of these phases.
- This procedure should have minimum to no mpact on host I/O.
- The procedure should be simple and easy to

**EMC**<sup>2</sup> where information lives

### 3 Phases of Failback Procedure

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### Mirror Memory Project Status

- Completed the Software Requirements Document (SRS)
- Started the Functional Spec
- Deep into design discussions
- Collecting design concepts and flowcharts for the High Level Design spec (HLDS)
- Developed a symm-6 prototype to demonstrate these concepts



### EXHIBIT B

Subject: RE: Mirrored Memory External Review Date:

From:araskiewicz, susan <araskiewicz\_susan@emc.com>

To:cartmell, jerry <artmell jerry@emc.com>, decrescenzo, bob <a href="mailto:decrescenzo\_bob@emc.com">decrescenzo\_bob@emc.com</a>, rosner, tim <a href="mailto:com">com</a> rosner tim@emc.com>

CC:mcclure, steven <smcclure@emc.com>

```
Great I will set it up. Who should be included in the meeting?
Thanks
Susan
  ----Original Message----
                cartmell, jerry
> From:
> Sent:
        decrescenzo, bob; araskiewicz, susan; rosner, tim
  To:
> Cc:
        mcclure, steven
> Subject:
                RE: Mirrored Memory External Review
> We can do a external review on the FS on ;
                                                                       ່ເຮ.)
> Jerry
>
         ----Original Message----
>
>
        From: decrescenzo, bob
        Sent:
        To:
                araskiewicz, susan; rosner, tim; cartmell, jerry
        Cc:
                mcclure, steven
        Subject:
                        RE: Mirrored Memory External Review
        I believe the fuctional spec is in good shape, but this is up to
> Jerry. He should be able to give you the state of the functional spec and
> also when he would be ready for an external review.
        --Bob
                 ----Original Message----
                From:
                        araskiewicz, susan
                Sent:
                        decrescenzo, bob; rosner, tim; cartmell, jerry
                Subject:
                                RE: Mirrored Memory External Review
>
                OK, so why don't I plan on scheduling an External Functional
> Review.
```

```
Bob does the document need to be revised or is it ready to
> be sent out for review before the external meeting. I can target setting
  the meeting up for next week if that works.
>
                Tim who needs to be on the external distribution list?
>
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                Thanks
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                Susan
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                          ----Original Message--
>
                                 decrescenzo, bob
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                        To:
                                 araskiewicz, susan; rosner, tim; cartmell,
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                        Yes. We only had an internal review. There has
> been nothing done externally.
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                                araskiewicz, susan
>
                        Sent:
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                                 decrescenzo, bob; rosner, tim; cartmell,
  jerry
                                         RE: Mirrored Memory External Review
                        Subject:
>
                        Bob, I was under the impression you already had the
 functional review.
                     Was it just an internal review?
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                        Susan
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                         ----Original Message----
                        From: decrescenzo, bob
                        To:
                                rosner, tim; araskiewicz, susan; cartmell,
  jerry
                        Subject:
                                        RE: Mirrored Memory External Review
                        I think they will get this from a functional review.
> I don't think anyone can get anything out of design review without having
> a functional review first. The functional review would explain "what" we
> are going to be doing. The design review explains "how" we did it
> internally in the code. If they don't thoroughly know and understand the
> "what" then the "how" is going to be meaningless.
>
                        --Bob
                         ----Original Message----
                        From:
                                rosner, tim
                        Sent:
                        To:
                                decrescenzo, bob; araskiewicz, susan;
 cartmell, jerry
>
                        Subject:
                                        RE: Mirrored Memory External Review
>
                       .Bob,
                        I understand your point, however if you don't mind I
> would like to continue with the external review. Trust me I will not
> allow any external group influence our design.
```

The reason why I want external involvement is > because I want to have them understand the extensive work your group is going threw and that it's not just a simple change. > TR > ----Original Message---> decrescenzo, bob > Sent: To: araskiewicz, susan; cartmell, jerry > Cc: rosner, tim > Subject: RE: Mirrored Memory External Review > > Susan, > I don't know if we want to have an external > design review. The only information that external groups should care > about is in the functional spec. We may want to have an external > functional review. I don't think product management, marketing, etc. > really care if we are using separate internal threads to do fail-over or > if we do this fail-over inside existing threads. This is the details in > the design spec. They really only care about how the feature going to > "function". If design questions come up we can explain how we are going > to implement something, but I don't think this should be the focus to > external groups. We don't want to give external groups the ability to > direct/change our designs. We want their feedback on how the feature is > going to function to make sure it's in alignment with what they expected. > I don't think this applies to our own internal designs. Tim, what do you think? > ----Original Message---araskiewicz, susan From: > Sent: To: cartmell, jerry Cc: decrescenzo, bob > Mirrored Memory External Review Hi Jerry, Congratulation on a very successful Internal Design Review for Mirrored Memory. Below are my meeting minutes from the Mirrored Memory Internal Design Review. Action Items: Need to come to an agreement with Vault. (Jerry) Wayne Sylvia will send question to Jerry. (Wayne) Discuss Special Command with Haim (Jerry) >

```
Discussions:

You still want SymWin Scripts

Scott Gordon will write a utility (Syscall) to light
the light (LED)

When would you like to schedule and External Review.
I want to give you enough time to complete the action items.

Thanks
Susan
```

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